TOSHIBA PHOTOCOUPLER PHOTO RELAY

TLP3113

MEASUREMENT INSTRUMENTS LOGIC IC TESTERS / MEMORY TESTERS BOARD TESTERS / SCANNERS

The TOSHIBA TLP3113 Mini-flat photorelay is a small-outline photorelay, suitable for surface-mount assembly. The TLP3113 consists of a GaAs infrared-emitting diode optically coupled to a photo-MOS FET and housed in a 4-pin package.

Its characteristics include low OFF-state current and low output pin capacitance, enabling it to be used in high-frequency measuring instruments.

Features

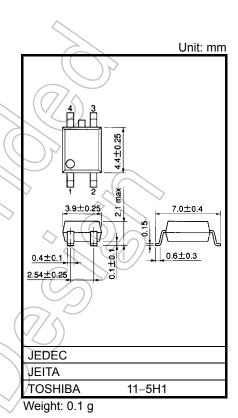
• 4 pin SOP (2.54SOP4) : 2.1 mm high, 2.54 mm pitch

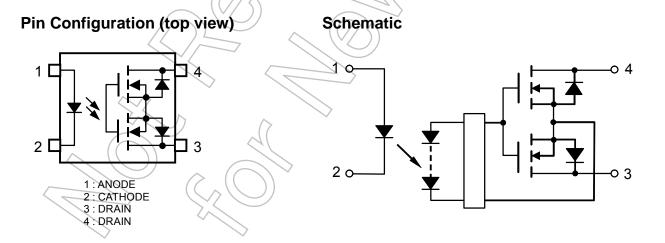
• 1-Form-A

Peak Off-State Voltage : 40 V (MIN.)
 Trigger LED Current : 4 mA (MAX.)
 On-State Current : 80 mA (MAX.)
 On-State Resistance : 35 Ω (MAX.), 25 Ω (TYP.)

• Output Capacitance : 1.4 pF (MAX.), 0.6 pF (TYP.)

• Isolation Voltage : 1500 Vrms (MIN.)





2007-10-01

Absolute Maximum Ratings (Ta = 25°C)

	CHARACTERISTIC	SYMBOL	RATING	UNIT	
	Forward Current	l _F	50	mA	
Ω	Forward Current Derating (Ta ≥ 25°C)	ΔI _F /°C	-0.5	mA/°C	
LED	Reverse Voltage	V_{R}	5	V	
	Junction Temperature	Tj	125	°C	
~	Off-State Output Terminal Voltage	V _{OFF}	40	v ((
DETECTOR	On-State Current	I _{ON}	80	mA	
ETĒ	On-State Current Derating (Ta ≥ 25°C)	Δl _{ON} /°C	-0.8	mA/°C	
	Junction Temperature	Tj	125	ိုင္မ	
Storage Temperature Range		T _{stg}	-40~125	°C	
Operating Temperature Range		T _{opr}	-20~85)°C	
Lead	Soldering Temperature (10 s)	T _{sol}	260	> ℃	
Isolat	tion Voltage (AC, 1 minute, R.H. \leq 60%) (NOTE1)	BVS	1500	Vrms	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

(NOTE1): Device considered a two-terminal device : Pins 1 and, 2 shorted together, and pins 3 and 4 shorted together.

CAUTION

This device is sensitive to electrostatic discharge. When using this device, please ensure that all tools and equipment are earthed.

Recommended Operating Conditions

		7/			
CHARACTERISTIC	SYMBOL	MIN.)	TYP.	MAX.	UNIT
Supply Voltage	V_{DD})		32	V
Forward Current	F	<u> </u>	_	30	mA
On-State Current	ION	_	_	80	mA
Operating Temperature	T _{opr}	25	_	60	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Individual Electrical Characteristics (Ta = 25°C)

	CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
	Forward Voltage	V _F	I _F = 10 mA	1.0	1.15	1.3	V
LED	Reverse Current	I _R	V _R = 5 V			10	μА
	Capacitance	C _T	V = 0, f = 1 MHz		15		pF
CTOR	Off-State Current	l _{OFF}	V _{OFF} = 30 V, Ta = 50°C	l	l	1000	pA
DETECTOR	Capacitance	C _{OFF}	V = 0, f = 100 MHz, t < 1 s		0.6	1.4	pF

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Coupled Electrical Characteristics (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Trigger LED Current	I _{FT}	I _{ON} = 80 mA	_	_	4	mA
Return LED Current	I _{FC}	I _{OFF} = 10 μA	0.2	0.75	_	mA
On-State Resistance	R _{ON}	$I_{ON} = 80 \text{ mA}, I_F = 5 \text{ mA}, t < 1 \text{ s}$	\Diamond	25	35	Ω

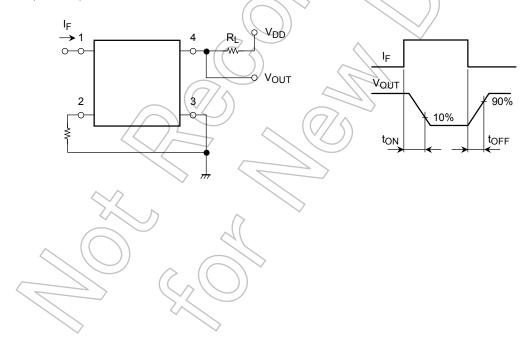
Isolation Characteristics (Ta = 25°C)

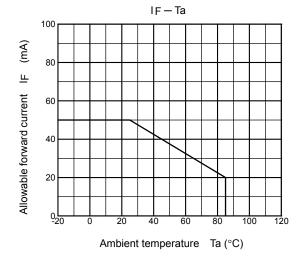
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Capacitance Input to Output	Cs	V _S = 0 V, f = 1 MHz		8.0	_	pF
Isolation Resistance	R _S	V _S = 500 V, R.H. ≦ 60%	5×10 ¹⁰	10 ¹⁴	_	Ω
		AC, 1 minute	1500	-((_	Vrms
Isolation Voltage	BV_S	S AC, 1 second (in oil) — 3000	3000		VIIIIS	
		DC, 1 minute (in oil)		3000	>-	Vdc

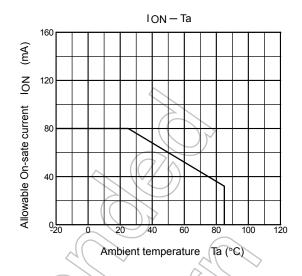
Switching Characteristics (Ta = 25°C)

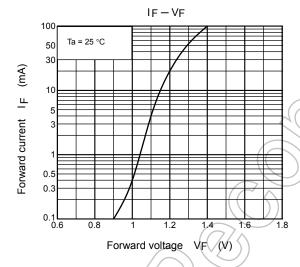
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Turn-on Time	t _{ON}	$R_L = 200 \Omega$ (NOTE 2)	77\	_	500	μS
Turn-off Time	t _{OFF}	$V_{DD} = 10 \text{ V}, \text{ IF} = 10 \text{ mA}$	\bigcirc	_	500	μο

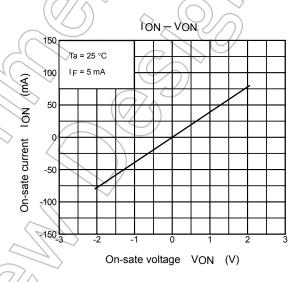
(NOTE 2): SWITCHING TIME TEST CIRCUIT

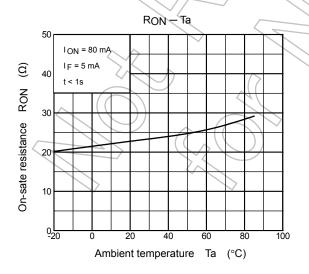


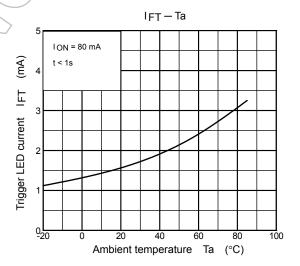


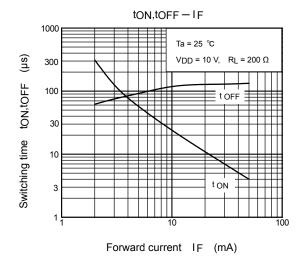


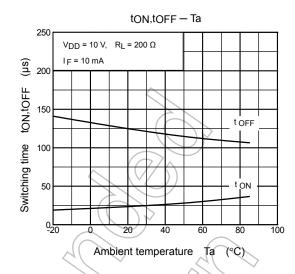


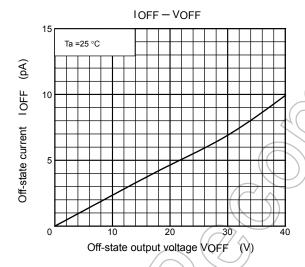


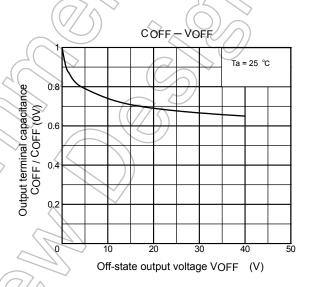












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